

# FAN7527B

## Power Factor Correction Controller

### Features

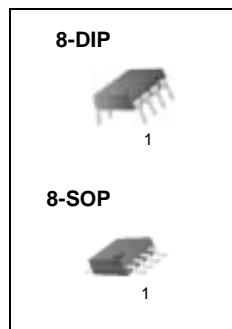
- Internal start-up timer
- Internal R/C filter eliminates the need for an external R/C filter
- Very precise adjustable output over voltage protection
- Zero current detector
- One quadrant multiplier
- Trimmed 1.5% internal band gap reference
- Under voltage lockout with 3V of hysteresis
- Totem pole output with high state clamp
- Low start-up and operating current
- 8-Pin DIP or 8-Pin SOP

### Applications

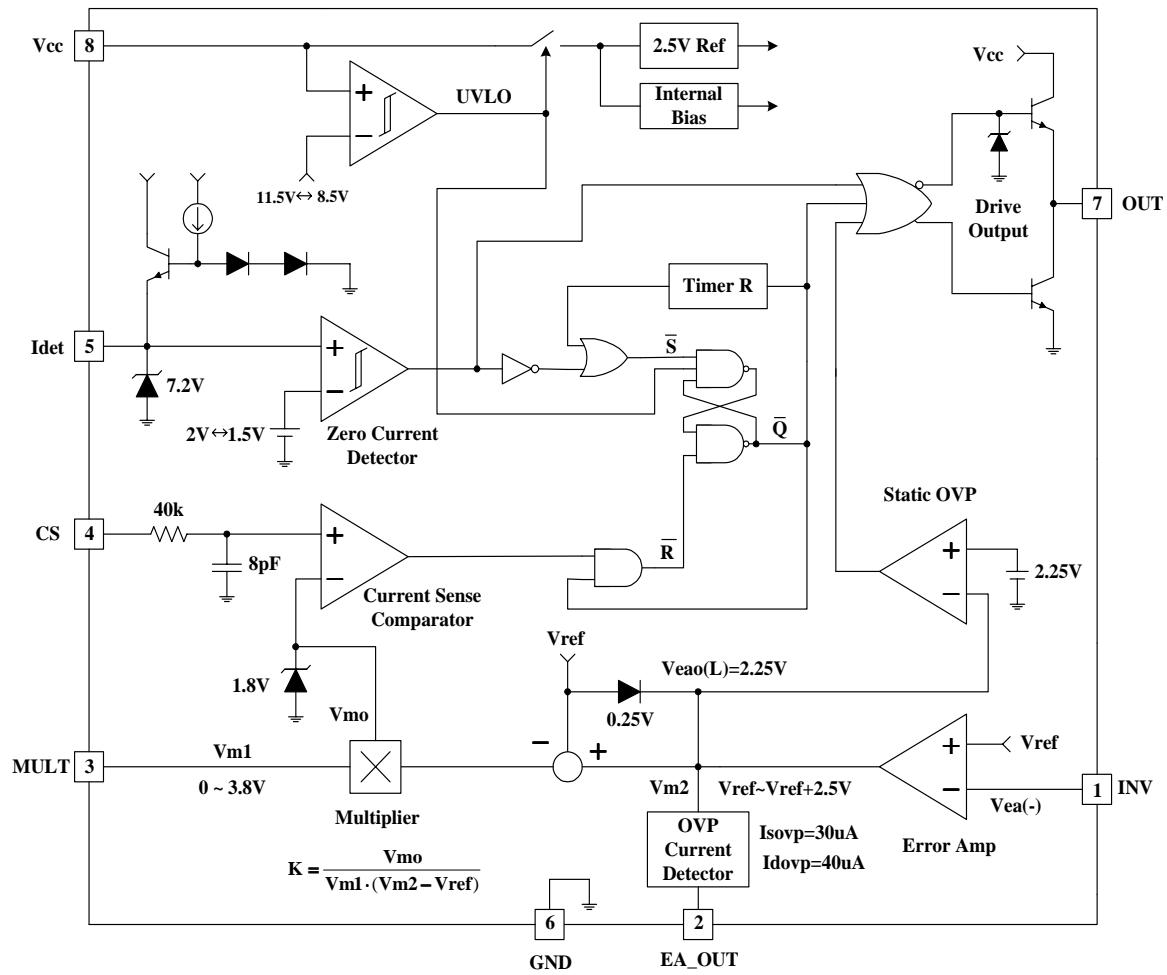
- Electronic ballast
- SMPS

### Description

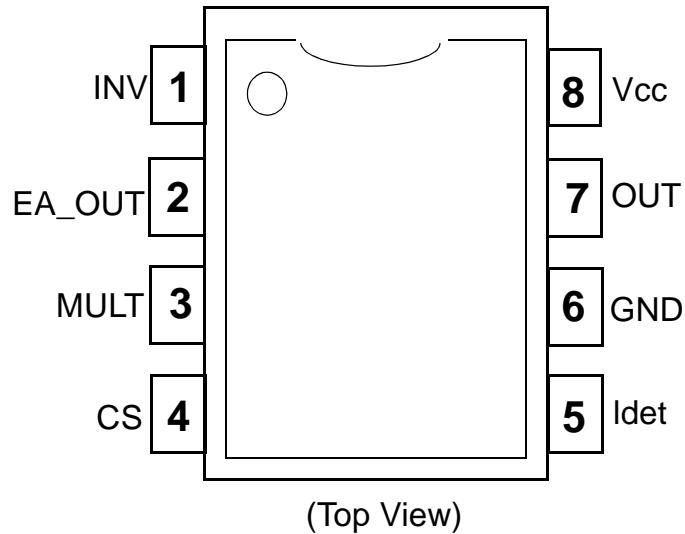
The FAN7527B provides simple and high performance active power factor correction. The FAN7527B is optimized for electronic ballasts and low power and high density power supplies which require minimum board size, reduced external components and low power dissipation. Because the R/C filter is included in the current sense block, the external R/C filter is not necessary. Special circuitry has also been added to prevent no load runaway conditions. Regardless of the supply voltage, the output drive clamping circuit limits the overshoot of the power MOSFET gate drive. It greatly enhances the system reliability.



## Internal Block Diagram



## PIN Description



Pin Number	Pin Name	Pin Function Description
1	INV	Inverting input of the error amplifier. the output of the boost converter should be resistively divided to 2.5V and connected to this pin.
2	EA_OUT	The output of the error amplifier. a feedback compensation network is placed between this pin and the INV pin.
3	MULT	Input to the multiplier stage. the full-wave rectified ac voltage is divided to less than 2V and is connected to this pin.
4	CS	Input of the PWM comparator. the MOSFET current is sensed by a resistor and the resulting voltage is applied to this pin. an internal R/C filter is included to reject any high frequency noise.
5	ldet	Zero current detection input.
6	GND	The ground potential of all the pins.
7	OUT	Gate driver output. the push pull output stage is able to drive the power MOSFET with peak current of 500mA.
8	Vcc	Supply voltage of driver and control circuits.

## Absolute Maximum Ratings (Ta=25°C)

Characteristics	Symbol	Value	Unit
Supply voltage	Vcc	30	V
Peak drive output current	IOH,IOL	±500	mA
Driver output clamping diodes Vo > Vcc or Vo < -0.3V	Iclamp	±10	mA
Detector clamping diodes	Idet	±10	mA
Error amp, multiplier and comparator input voltages	Vin	-0.3 to 6	V
Operating junction temperature	Tj	150	°C
Operating temperature range	Topr	-25 to 125	°C
Storage temperature range	Tstg	-65 to 150	°C
Power dissipation	8-DIP	Pd	1.1
	8-SOP		0.8
			W

## Thermal Data

Characteristics	Symbol	Value	Unit
Thermal resistance junction-ambient Max.	8-DIP	Rθja	110
	8-SOP		150
			°C/W

## Temperature Characteristics (-25°C ≤ Ta ≤ 125°C)

Characteristics	Symbol	Min.	Typ.	Max.	Unit
Temperature stability for reference voltage (Vref)	ΔVref	-	20	-	mV
Temperature stability for multiplier gain (K)	ΔK/ΔT	-	-0.2	-	%/°C

## Electrical Characteristics

V<sub>CC</sub>= 14V, -25°C ≤ Ta ≤ 125°C, unless otherwise stated.

Characteristics	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>&lt; UNDER VOLTAGE LOCKOUT SECTION&gt;</b>						
Start threshold voltage	V <sub>th(st)</sub>	V <sub>CC</sub> Increasing	10.5	11.5	12.5	V
UVLO hysteresis	H <sub>Y(st)</sub>	-	2	3	4	V
<b>&lt; SUPPLY CURRENT SECTION &gt;</b>						
Start-up supply current	I <sub>st</sub>	V <sub>CC</sub> = V <sub>th(st)</sub> -0.2V	10	60	100	uA
Operating supply current	I <sub>cc</sub>	Output not switching	-	3	6	mA
Operating current at OVP	I <sub>cc(ovp)</sub>	V <sub>INV</sub> = 3V	-	1.7	4	mA
Dynamic operating supply current	I <sub>dcc</sub>	50kHz, C <sub>I</sub> = 1nF	-	4	8	mA
<b>&lt; ERROR AMPLIFIER SECTION &gt;</b>						
Voltage feedback input threshold	V <sub>ref</sub>	I <sub>ref</sub> = 0mA, Ta = 25°C	2.465	2.5	2.535	V
		-25 ≤ Ta ≤ 125°C	2.44	2.5	2.56	V
Line regulation	ΔV <sub>ref1</sub>	14V ≤ V <sub>CC</sub> ≤ 25V	-	0.1	10	mV
Temperature stability of V <sub>ref</sub> (Note1)	ΔV <sub>ref3</sub>	-25 ≤ Ta ≤ 125°C	-	20	-	mV
Input bias current	I <sub>b(ea)</sub>	-	-0.5	-	0.5	uA
Output source current	I <sub>source</sub>	V <sub>M2</sub> = 4V	-2	-4	-	mA
Output sink current	I <sub>sink</sub>	V <sub>M2</sub> = 4V	2	4	-	mA
Output upper clamp voltage (Note2)	V <sub>eao(H)</sub>	I <sub>source</sub> = 0.1mA	-	6	-	V
Output lower clamp voltage (Note3)	V <sub>eao(L)</sub>	I <sub>sink</sub> = 0.1mA	-	2.25	-	V
Large signal open loop gain (Note4)	G <sub>V</sub>	-	60	80	-	dB
Power supply rejection ratio (Note5)	PSRR	14V ≤ V <sub>CC</sub> ≤ 25V	60	80	-	dB
Unity gain bandwidth (Note6)	GBW	-	-	1	-	MHz
Slew rate (Note7)	SR	-	-	0.6	-	V/us
<b>&lt; MULTIPLIER SECTION&gt;</b>						
Input bias current (pin3)	I <sub>b(m)</sub>	-	-0.5	-	0.5	uA
M1 input voltage range (pin3)	ΔV <sub>m1</sub>	-	0	-	3.8	V
M2 input voltage range (pin2)	ΔV <sub>m2</sub>	-	V <sub>ref</sub>	-	V <sub>ref</sub> +2.5	V
Multiplier gain (Note8)	K	V <sub>M1</sub> = 1V, V <sub>M2</sub> = 3.5V	0.36	0.44	0.52	1/V
Maximum multiplier output voltage	V <sub>omax(m)</sub>	V <sub>INV</sub> = 0V, V <sub>M1</sub> = 4V	1.65	1.8	1.95	V
Temperature stability of K (Note9)	ΔK/ΔT	-25 ≤ Ta ≤ 125°C	-	-0.2	-	%/°C

**Electrical Characteristics** (Continued)

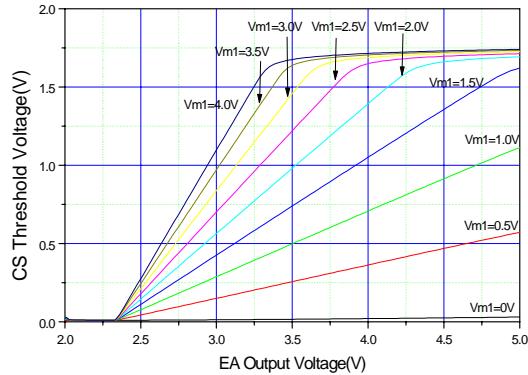
VCC= 14V, -25°C ≤ Ta ≤ 125°C, unless otherwise stated.

Characteristics	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>&lt; CURRENT SENSE SECTION&gt;</b>						
Input offset voltage (Note8)	Vio(cs)	Vm1=0V , Vm2 = 2.2V	-10	3	10	mV
Input bias current	Ib(cs)	0V ≤ Vcs ≤ 1.7V	-1	-0.1	1	uA
Current sense delay to output (Note11)	td(cs)	-	-	200	500	ns
<b>&lt; ZERO CURRENT DETECT SECTION &gt;</b>						
Input voltage threshold	Vth(det)	Vdet increasing	1.7	2	2.3	V
Detect hysteresis	HY(det)	-	0.2	0.5	0.8	V
Input low clamp voltage	Vclamp(l)	Idet = -100uA	0.45	0.75	1	V
Input high clamp voltage	Vclamp(h)	Idet = 3mA	6.5	7.2	7.9	V
Input bias current	Ib(det)	1V ≤ Vdet ≤ 5V	-1	-0.1	1	uA
Input high/low clamp diode current (Note12)	Iclamp(d)	-	-	-	±3	mA
<b>&lt; OUTPUT SECTION &gt;</b>						
Output voltage high	Voh	Io = -10mA	10.5	11	-	V
Output voltage low	Vol	Io = 10mA	-	0.8	1	V
Rising time (Note13)	tr	Cl = 1nF	-	130	200	ns
Falling time (Note14)	tf	Cl = 1nF	-	50	120	ns
Maximum output voltage	Vomax(o)	Vcc = 20V, Io = 100uA	12	14	16	V
Output voltage with UVLO activated	Vomin(o)	Vcc = 5V , Io = 100uA	-	-	1	V
<b>&lt; RESTART TIMER SECTION&gt;</b>						
Restart time delay	td(rst)	Vm1 = 1V, Vm2 = 3.5V	-	150	-	us
<b>&lt;OVER VOLTAGE PROTECTION SECTION&gt;</b>						
Soft OVP detecting current	Isovp	-	25	30	35	uA
Dynamic OVP detecting current	Idovp	-	35	40	45	uA
Static OVP threshold voltage	Vovp	Vinv = 2.7V	2.1	2.25	2.4	V

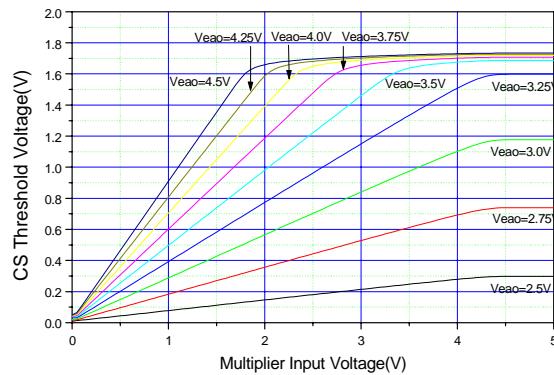
**Note 1 ~ 14:** These parameters, although guaranteed, are not 100% tested in production.

$$\text{Multiplier Gain: } K = \frac{\text{Pin4_Threshold}}{\text{Vm1} \times (\text{Vm2} - \text{Vref})} \dots \dots (\text{Vm1} = \text{Vpin3}, \text{Vm2} = \text{Vpin2})$$

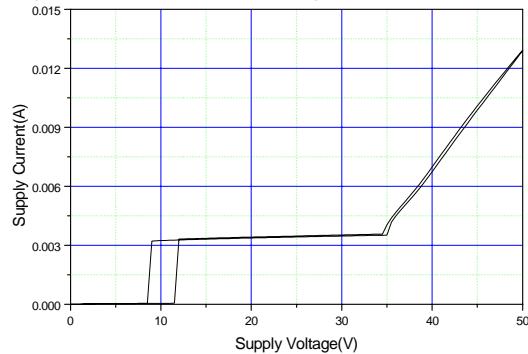
## Typical Performance Characteristics



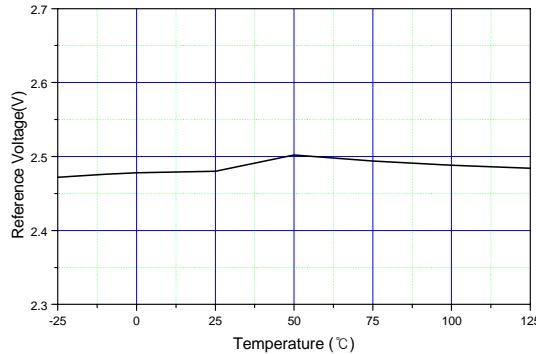
**Figure 1. Error Amplifier Output Voltage vs Current Sensing Threshold**



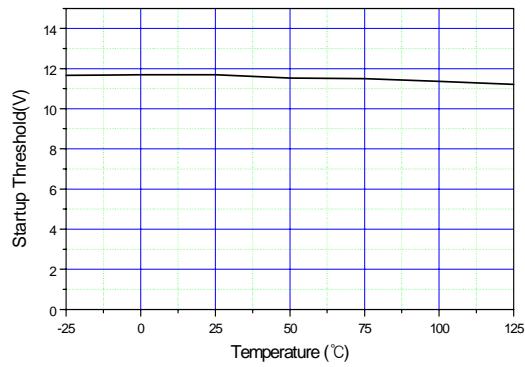
**Figure 2. Multiplier Input Voltage vs Current Sensing Threshold**



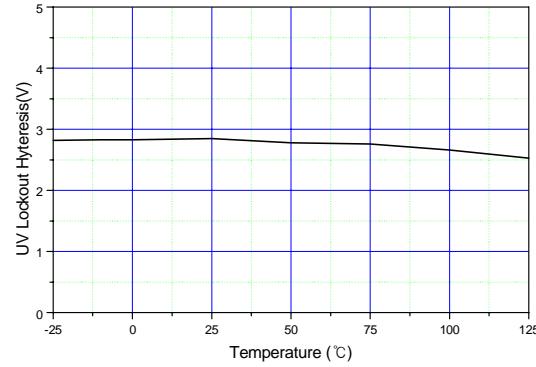
**Figure 3. Supply Current vs Supply Voltage**



**Figure 4. Reference Voltage vs Temperature**



**Figure 5. Start-Up Threshold vs Temperature**



**Figure 6. UV Lockout Hysteresis vs Temperature**

## Typical Performance Characteristics (Continued)

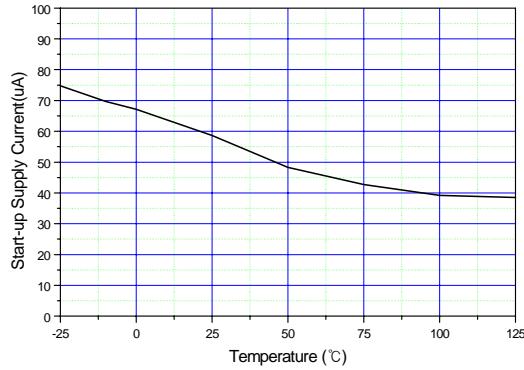


Figure 7. Start-Up Supply Current vs Temperature

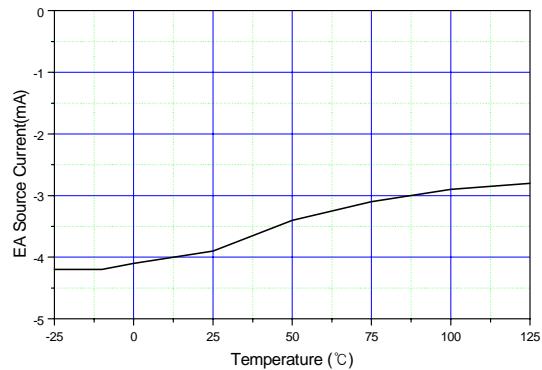


Figure 8. Error Amplifier Source Current vs Temperature

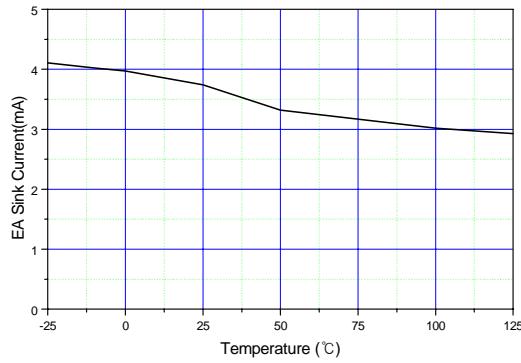


Figure 9. Error Amplifier Sink Current vs Temperature

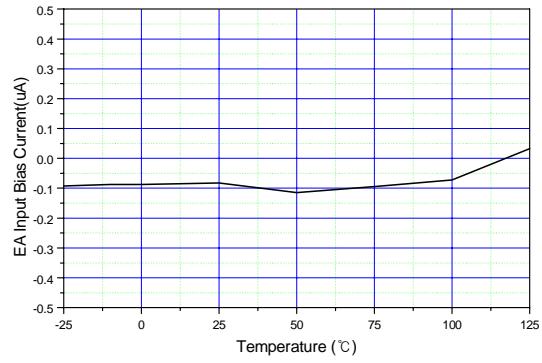


Figure 10. Error Amplifier Input Bias Current vs Temperature

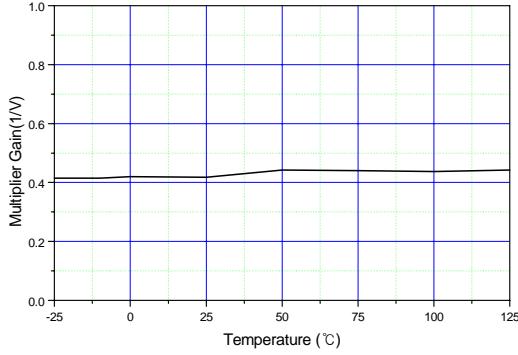


Figure 11. Multiplier Gain vs Temperature

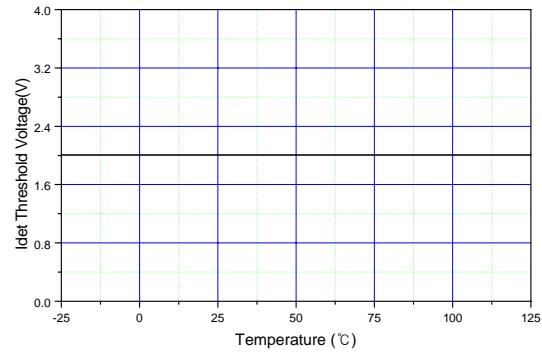


Figure 12. Idet Threshold Voltage vs Temperature

## Typical Performance Characteristics (Continued)

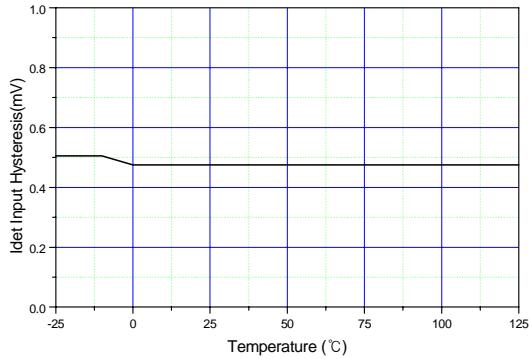


Figure 13. Idet Input Hysteresis vs Temperature

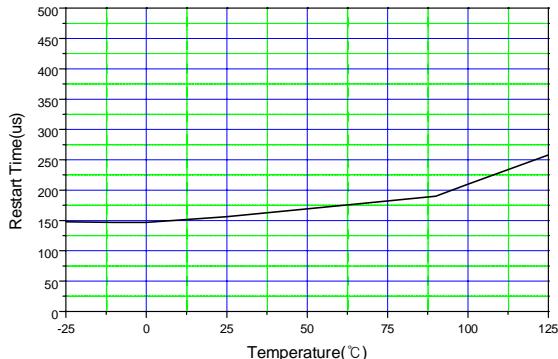


Figure 14. Restart Time vs Temperature

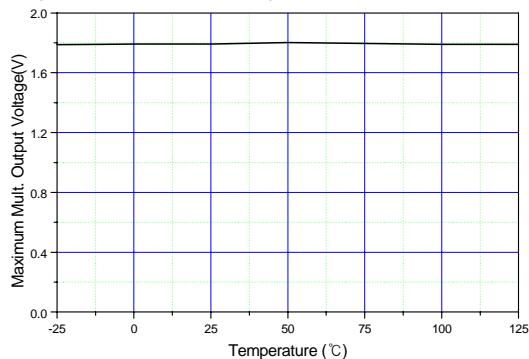


Figure 15. Max.Mult.Output Voltage vs Temperature

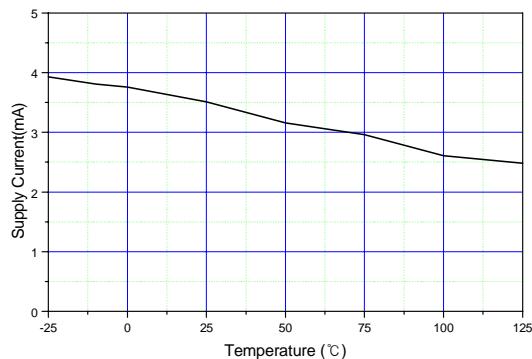


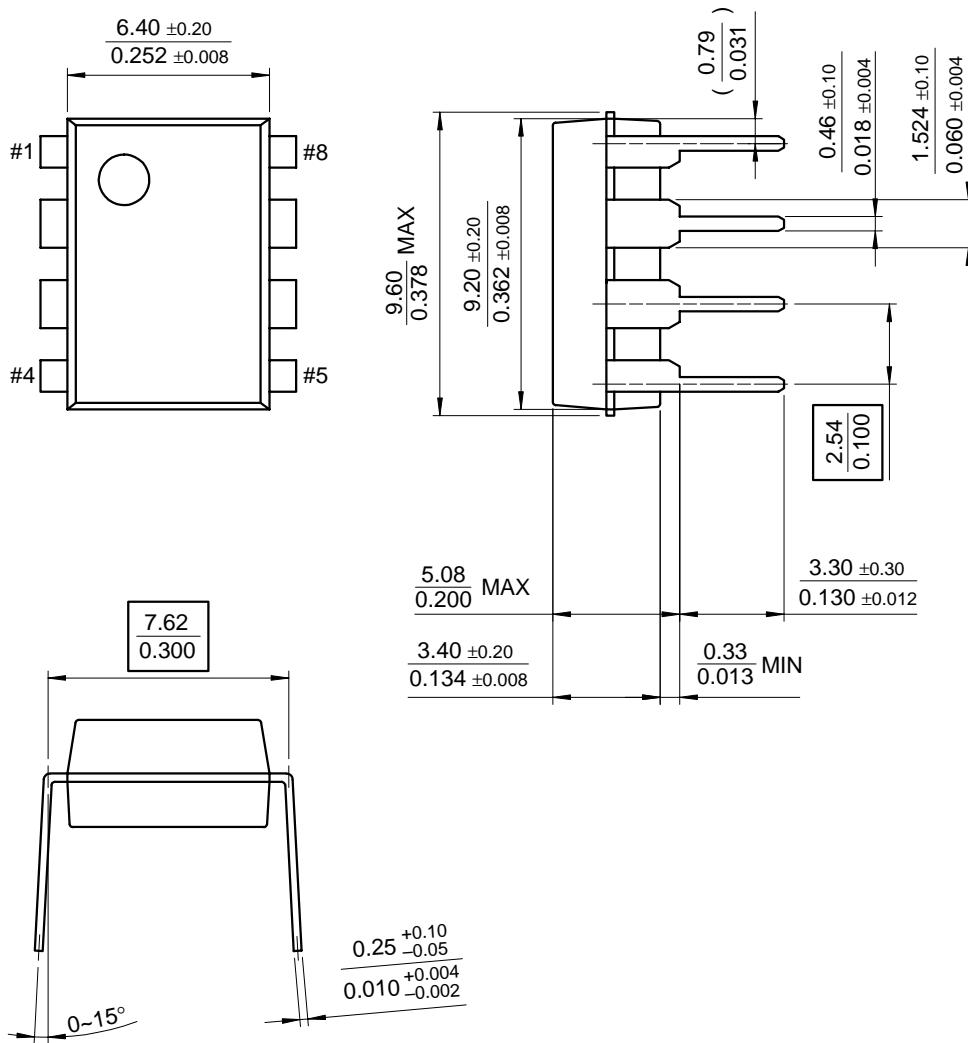
Figure 16. Supply Current vs Temperature

## Mechanical Dimensions

### Package

Dimensions in millimeters

### 8-DIP

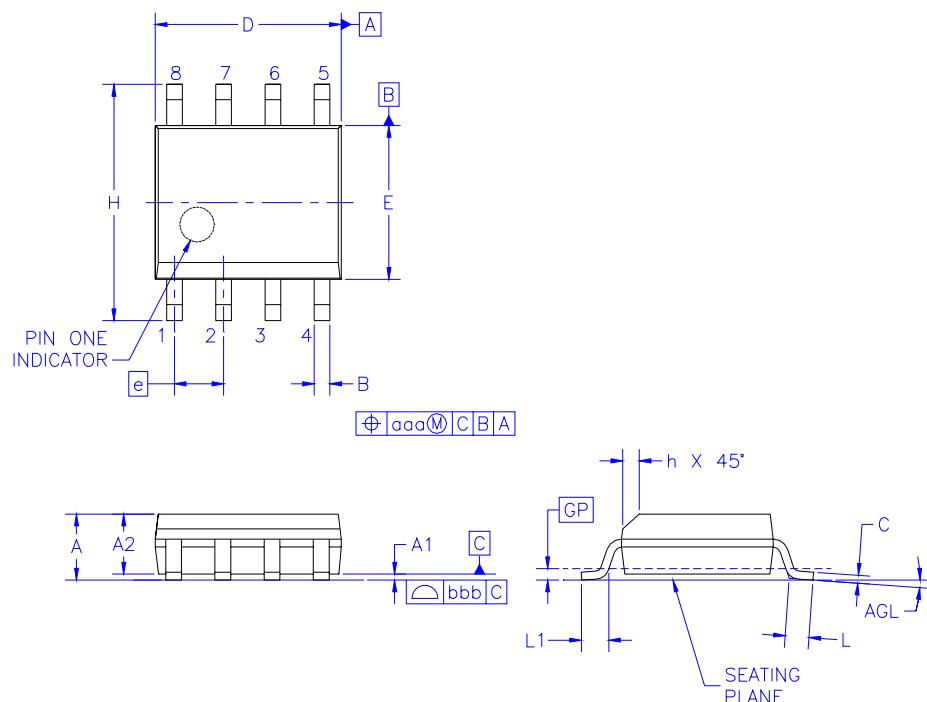


## Mechanical Dimensions (Continued)

### Package

Dimensions in millimeters

### 8-SOP



Symbol	Min	Nom	Max
A	-	-	1.75
A1	0.10	0.15	0.25
A2	1.25	1.45	1.50
B	0.35	0.37	0.51
C	0.19	0.20	0.25
D	4.80	4.90	5.00
E	3.80	3.90	4.00
e	1.27BSC		
H	5.79	5.99	6.20
h	0.25	-	0.50
L	0.50	0.70	0.90
GP	0.36 BSC		
q	0	-	8
aaa	-	-	0.25
bbb	-	-	0.10

## Ordering Information

Product Number	Package	Operating Temperature
FAN7527BN	8-DIP	-25 ~ +125°C
FAN7527BM	8-SOP	

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